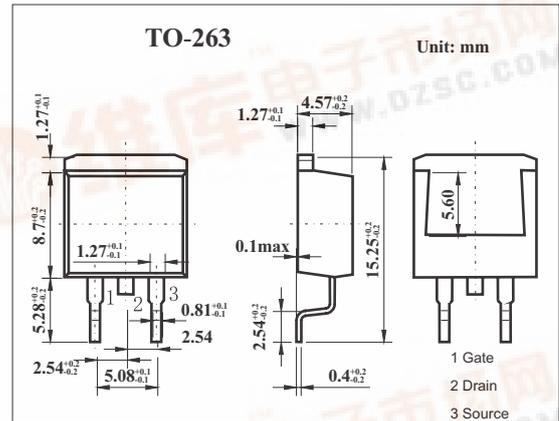


SMD Type MOSFET

MOS Field Effect Transistor
2SK3433

■ Features

- Super low on-state resistance:
 $R_{DS(on)1} = 26m\Omega$ MAX. ($V_{GS} = 10V, I_D = 42A$)
 $R_{DS(on)2} = 41m\Omega$ MAX. ($V_{GS} = 4V, I_D = 42A$)
- Low C_{iss} : $C_{iss} = 1500pF$ TYP.
- Built-in gate protection diode



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	± 40	A
	I_{dp}^*	± 160	A
Power dissipation	$T_C=25^\circ C$	P_D	47
	$T_A=25^\circ C$		1.5
Channel temperature	T_{ch}	150	$^\circ C$
Storage temperature	T_{stg}	-55 to +150	$^\circ C$

* $PW \leq 10\mu s, Duty\ Cycle \leq 1\%$

■ Electrical Characteristics $T_a = 25^\circ C$

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain cut-off current	I_{DSS}	$V_{DS}=60V, V_{GS}=0$			10	μA
Gate leakage current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0$			± 10	μA
Gate cutoff voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	1.5	2.0	2.5	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS}=10V, I_D=20A$	11	22		S
Drain to source on-state resistance	$R_{DS(on)1}$	$V_{GS}=10V, I_D=20A$		22	26	$m\Omega$
	$R_{DS(on)2}$	$V_{GS}=4V, I_D=20A$		29	41	$m\Omega$
Input capacitance	C_{iss}	$V_{DS}=10V, V_{GS}=0, f=1MHz$		1500		pF
Output capacitance	C_{oss}			250		pF
Reverse transfer capacitance	C_{rss}			120		pF
Turn-on delay time	t_{on}	$I_D=20A, V_{GS(on)}=10V, R_G=10\Omega, V_{DD}=30V$		35		ns
Rise time	t_r			320		ns
Turn-off delay time	t_{off}			89		ns
Fall time	t_f			120		ns
Total Gate Charge	Q_G			30		nC
Gate to Source Charge	Q_{GS}	$I_D=40A, V_{DD}=48V, V_{GS}=10V$		5		nC
Gate to Drain Charge	Q_{GD}			8		nC

